

PATENT ASSIGNMENT COVER SHEET

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EPAS ID: PAT4738373

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
HIRONOBU MORITA	12/04/2017
MOTOHARU OKUNO	12/06/2017
YASUHITO UETSUJI	12/08/2017
KAZUNARI KOMAI	12/07/2017
TAKUYA MATSUSHIMA	12/06/2017
YUSUKE IIDA	12/07/2016
SEHO SEO	12/07/2017
RECEIVING PARTY DATA	
Name:	OMRON CORPORATION
Street Address:	801, MINAMIFUDODO-CHO, HORIKAWAHIGASHIIRU, SHIOKOJI-DORI, SHIMOGYO-KU, KYOTO-SHI,
City:	KYOTO
State/Country:	JAPAN
Postal Code:	600-8530
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	15842896
CORRESPONDENCE DATA	
Fax Number:	(510)580-7280
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
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ATTORNEY DOCKET NUMBER:	74525-US-540
NAME OF SUBMITTER:	BELINDA LEE
SIGNATURE:	/Belinda Lee/
DATE SIGNED:	12/18/2017

Total Attachments: 6

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**DECLARATION AND ASSIGNMENT
FOR UTILITY OR DESIGN PATENT APPLICATION**

☒ Declaration Submitted With Initial Filing

OR

☐ Declaration Submitted After Initial Filing (surcharge 37 CFR 1.16(f) required)

(Title of the Invention)

PHOTOSENSOR AND SENSOR SYSTEM

As a below named inventor (hereinafter designated as the undersigned), I hereby declare that:

This declaration is directed to:

☒ The attached application,

OR

☐ United States Application Number or PCT International application number

Filed on _____

The above-identified application was made or authorized to be made by me.

I believe I am the original inventor or an original joint inventor of a claimed invention in the application.

The undersigned hereby acknowledge that any willful false statement made in this declaration is punishable under 18 U.S.C. 1001 by fine or imprisonment of not more than five (5) years, or both.

**DECLARATION AND ASSIGNMENT
FOR UTILITY OR DESIGN PATENT APPLICATION**

WHEREAS, the undersigned has invented certain new and useful improvements described in the application identified.

WHEREAS, OMRON Corporation (Name of Assignee)

of 801, Minamifudodo-cho, Horikawahigashiiru, Shiokoji-dori, Shimogyo-Ku, Kyoto-shi, KYOTO 600-8530, JAPAN (Address of Assignee)

hereinafter referred to as ASSIGNEE, is desirous of acquiring the undersigned's interest in the said invention and application and in any U.S. Letters Patent which may be granted on the same:

NOW, THEREFORE, TO ALL WHOM IT MAY CONCERN: Be it known that, for good and valuable consideration, receipt of which is hereby acknowledged by the undersigned, the undersigned has/have sold, assigned and transferred, and by these presents does/do sell, assign and transfer unto the said Assignee, and Assignee's successors and assigns, all his/her/their rights, title and interest in and to the said invention and application and all future improvements thereon, and in and to any Letters Patent which may hereafter be granted on the same in the United States, the said rights, title and interest to be held and enjoyed by said Assignee as fully and exclusively as it would have been held and enjoyed by said the undersigned had this Assignment and transfer not been made, to the full end and term of any Letters Patent which may be granted thereon, or of any division, renewal, continuation in whole or in part, substitution, conversion, reissue, prolongation or extension thereof.

The undersigned further agrees/agree that he/she/they will, without charge to said Assignee, but at Assignee's expense, cooperate with Assignee in the prosecution of said application and/or applications, execute, verify, acknowledge and deliver all such further papers, including applications for Letters Patent and for the reissue thereof, and instruments of assignment and transfer thereof, and will perform such other acts as Assignee Lawfully may request, to obtain or maintain Letters Patent for said invention and improvement, and to vest title thereto in said Assignee, or Assignee's successors and assigns.

**DECLARATION AND ASSIGNMENT
FOR UTILITY OR DESIGN PATENT APPLICATION**

Signature:	<i>Hironobu Morita</i>	Date:	<i>12 / 4 / 2017</i>
<p>Legal Name of Sole or First Inventor: Hironobu MORITA</p> <p>Residence: Kyoto-shi, KYOTO, JAPAN</p> <p>Mailing Address: c/o OMRON Corporation, 801, Minamifudodo-cho, Horikawahigashiiru, Shiokoji-dori, Shimogyo-Ku, Kyoto-shi, KYOTO 600-8530, JAPAN</p>			
Signature:		Date:	
<p>Legal Name of Additional Joint Inventor: Motoharu OKUNO</p> <p>Residence: Fukuchiyama-shi, KYOTO, JAPAN</p> <p>Mailing Address: c/o OMRON Corporation, 801, Minamifudodo-cho, Horikawahigashiiru, Shiokoji-dori, Shimogyo-ku, Kyoto-shi, Kyoto 600-8530, Japan</p>			
Signature:		Date:	
<p>Legal Name of Additional Joint Inventor: Yasuhito UETSUJI</p> <p>Residence: Kusatsu-shi, SHIGA, JAPAN</p> <p>Mailing Address: c/o OMRON Corporation, 801, Minamifudodo-cho, Horikawahigashiiru, Shiokoji-dori, Shimogyo-ku, Kyoto-shi, Kyoto 600-8530, Japan</p>			

**DECLARATION AND ASSIGNMENT
FOR UTILITY OR DESIGN PATENT APPLICATION**

Signature:		Date:	
<p>Legal Name of Sole or First Inventor: Hironobu MORITA</p> <p>Residence: Kyoto-shi, KYOTO, JAPAN</p> <p>Mailing Address: c/o OMRON Corporation, 801, Minamifudodo-cho, Horikawahigashiiru, Shiokoji-dori, Shimogyo-Ku, Kyoto-shi, KYOTO 600-8530, JAPAN</p>			
Signature:	<i>M. Okuno</i>	Date:	<i>Dec. 6, 2017</i>
<p>Legal Name of Additional Joint Inventor: Motoharu OKUNO</p> <p>Residence: Fukuchiyama-shi, KYOTO, JAPAN</p> <p>Mailing Address: c/o OMRON Corporation, 801, Minamifudodo-cho, Horikawahigashiiru, Shiokoji-dori, Shimogyo-ku, Kyoto-shi, Kyoto 600-8530, Japan</p>			
Signature:	<i>Y. Uetsuji</i>	Date:	<i>Dec. 8, 2017</i>
<p>Legal Name of Additional Joint Inventor: Yasuhito UETSUJI</p> <p>Residence: Kusatsu-shi, SHIGA, JAPAN</p> <p>Mailing Address: c/o OMRON Corporation, 801, Minamifudodo-cho, Horikawahigashiiru, Shiokoji-dori, Shimogyo-ku, Kyoto-shi, Kyoto 600-8530, Japan</p>			

**DECLARATION AND ASSIGNMENT
FOR UTILITY OR DESIGN PATENT APPLICATION**

Signature:	<i>Kazunari Komai</i>	Date:	<i>07 / 12 / 2017</i>
Legal Name of Additional Joint Inventor: Kazunari KOMAI			
Residence: Kameoka-shi, KYOTO, JAPAN			
Mailing Address: c/o OMRON Corporation, 801, Minamifudodo-cho, Horikawahigashiiru, Shiokoji-dori, Shimogyo-ku, Kyoto-shi, Kyoto 600-8530, Japan			
Signature:	<i>Takuya MATSUSHIMA</i>	Date:	<i>T.M 06/12/2017</i> 6th, Dec, 17
Legal Name of Additional Joint Inventor: Takuya MATSUSHIMA			
Residence: Ayabe-shi, KYOTO, JAPAN			
Mailing Address: c/o OMRON Corporation, 801, Minamifudodo-cho, Horikawahigashiiru, Shiokoji-dori, Shimogyo-ku, Kyoto-shi, Kyoto 600-8530, Japan			
Signature:	<i>Yusuke Iida</i>	Date:	<i>07 / 12 / 2017</i>
Legal Name of Additional Joint Inventor: Yusuke IIDA			
Residence: Ayabe-shi, KYOTO, JAPAN			
Mailing Address: c/o OMRON Corporation, 801, Minamifudodo-cho, Horikawahigashiiru, Shiokoji-dori, Shimogyo-ku, Kyoto-shi, Kyoto 600-8530, Japan			

**DECLARATION AND ASSIGNMENT
FOR UTILITY OR DESIGN PATENT APPLICATION**

Signature:	SEHO SEO	Date:	2017 / 12 / 17
<p>Legal Name of Additional Joint Inventor: Seho SEO</p> <p>Residence: Fukuchiyama-shi, KYOTO, JAPAN</p> <p>Mailing Address: c/o OMRON Corporation, 801, Minamifudodo-cho, Horikawahigashiiru, Shiokoji-dori, Shimogyo-ku, Kyoto-shi, Kyoto 600-8530, Japan</p>			